SiHB21N60EF



Vishay Siliconix

RoHS

COMPLIANT HALOGEN

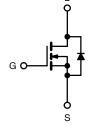
FREE

EF Series Power MOSFET with Fast Body Diode

| PRODUCT SUMMARY | | | | | | |
|--|-----------------|-------|--|--|--|--|
| V _{DS} (V) at T _J max. | 650 | | | | | |
| R _{DS(on)} max. at 25 °C (Ω) | $V_{GS} = 10 V$ | 0.176 | | | | |
| Q _g (Max.) (nC) | 84 | | | | | |
| Q _{gs} (nC) | 14 | | | | | |
| Q _{gd} (nC) | 24 | | | | | |
| Configuration | Sing | le | | | | |

D²PAK (TO-263)





N-Channel MOSFET

FEATURES

- Fast body diode MOSFET using E series technology
- Reduced t_{rr}, Q_{rr}, and I_{RRM}
- Low figure-of-merit (FOM): Ron x Qg
- Low input capacitance (Ciss)
- Increased robustness due to low Q_{rr}
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Telecommunications
 - Server and telecom power supplies
- Lighting
 - High intensity discharge (HID)
 - Light emitting diodes (LEDs)
- · Consumer and computing - ATX power supplies
- Industrial
 - Welding
- Battery chargers Renewable energy
 - Solar (PV inverters)
- Switch mode power suppliers (SMPS)
- · Applications using the following topologies
 - LLC
 - Phase shifted bridge (ZVS)
 - 3-level inverter
 - AC/DC bridge

| ORDERING INFORMATION | |
|---------------------------------|-----------------------------|
| Package | D ² PAK (TO-263) |
| Lead (Pb)-free and Halogen-free | SiHB21N60EF-GE3 |

| ABSOLUTE MAXIMUM RATINGS (T _C = | = 25 °C, unl | ess otherwis | se noted) | | |
|---|-----------------------------------|---|--------------------|----|---|
| PARAMETER | SYMBOL | LIMIT | UNIT | | |
| Drain-Source Voltage | V _{DS} | 600 | - V | | |
| Gate-Source Voltage | V _{GS} | ± 30 | v | | |
| Continuous Durain Current (T. 150 °C) | V at 10 V | $T_{C} = 25 \text{ °C}$ $T_{C} = 100 \text{ °C}$ | - I _D - | 21 | |
| Continuous Drain Current (T _J = 150 °C) | V _{GS} at 10 V | T _C = 100 °C | | 14 | А |
| Pulsed Drain Current ^a | I _{DM} 53 | 53 | 7 | | |
| Linear Derating Factor | | 1.8 | W/°C | | |
| Single Pulse Avalanche Energy ^b | E _{AS} | 367 | mJ | | |
| Maximum Power Dissipation | | P _D | 227 | W | |
| Operating Junction and Storage Temperature Range | T _J , T _{stg} | -55 to +150 | °C | | |
| Drain-Source Voltage Slope | 125 °C | -11//-11 | 70 | | |
| Reverse Diode dV/dt ^d | dV/dt | 50 | V/ns | | |
| Soldering Recommendations (Peak Temperature) ^c | | 300 | °C | | |

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. $V_{DD} = 50$ V, starting $T_J = 25$ °C, L = 28.2 mH, $R_g = 25 \Omega$, $I_{AS} = 5.1$ A.

c. 1.6 mm from case.

d. $I_{SD} \leq I_D$, dI/dt = 900 A/µs, starting T_J = 25 °C.

S17-0299-Rev. B, 27-Feb-17





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| THERMAL RESISTANCE RATINGS | | | | | | | |
|----------------------------------|-------------------|------|------|-------|--|--|--|
| PARAMETER | SYMBOL | TYP. | MAX. | UNIT | | | |
| Maximum Junction-to-Ambient | R _{thJA} | - | 62 | °C 4M | | | |
| Maximum Junction-to-Case (Drain) | R _{thJC} | _ | 0.55 | °C/W | | | |

| PARAMETER | SYMBOL | TES | MIN. | TYP. | MAX. | UNIT | |
|---|-----------------------|--|---|------|-------|-------|----|
| Static | | | | | | | |
| Drain-Source Breakdown Voltage | V _{DS} | V _{GS} | 600 | - | - | V | |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | Referenc | - | 0.59 | - | V/°C | |
| Gate-Source Threshold Voltage (N) | V _{GS(th)} | V _{DS} = | 2.0 | - | 4.0 | V | |
| Cata Cauraa Laakara | I _{GSS} | | - | - | ± 100 | nA | |
| Gate-Source Leakage | | | V _{GS} = ± 30 V | - | - | ± 1 | μA |
| | | V _{DS} = | = 480 V, V _{GS} = 0 V | - | - | 1 | |
| Zero Gate Voltage Drain Current | | V _{DS} = 480 \ | V _{DS} = 480 V, V _{GS} = 0 V, T _J = 125 °C | | | 500 | μA |
| Drain-Source On-State Resistance | R _{DS(on)} | $V_{GS} = 10 V$ | I _D = 11 A | - | 0.153 | 0.176 | Ω |
| Forward Transconductance | 9 _{fs} | V _{DS} | = 30 V, I _D = 11 A | - | 7 | - | S |
| Dynamic | | <u>.</u> | | | | | |
| Input Capacitance | C _{iss} | | $V_{GS} = 0 V,$ | - | 2030 | - | |
| Output Capacitance | C _{oss} | | V _{DS} = 100 V, | - | 105 | - | |
| Reverse Transfer Capacitance | C _{rss} | | f = 1 MHz | - | 5 | - | |
| Effective output capacitance, energy related ^a | C _{o(er)} | | V_{GS} = 0 V, V_{DS} = 0 V to 480 V | | 86 | - | pF |
| Effective output capacitance, time related ^b | C _{o(tr)} | $v_{GS} = 0$ | | | 299 | - | |
| Total Gate Charge | Qg | | | - | 56 | 84 | nC |
| Gate-Source Charge | Q _{gs} | $V_{GS} = 10 V$ | I _D = 11 A, V _{DS} = 480 V | - | 14 | - | |
| Gate-Drain Charge | Q _{gd} | | | - | 24 | - | |
| Turn-On Delay Time | t _{d(on)} | | | - | 21 | 42 | |
| Rise Time | t _r | V _{DD} = | V _{DD} = 480 V, I _D = 11 A | | 31 | 62 | |
| Turn-Off Delay Time | t _{d(off)} | $R_g = 1$ | 9.1 Ω, V _{GS} = 10 V | - | 59 | 89 | ns |
| Fall Time | t _f | | | - | 27 | 54 | |
| Gate Input Resistance | Rg | f = 1 MHz, open drain | | 0.2 | 0.56 | 1.2 | Ω |
| Drain-Source Body Diode Characteristic | s | • | | • | • | • | |
| Continuous Source-Drain Diode Current | I _S | MOSFET sym | MOSFET symbol | | - | 21 | |
| Pulsed Diode Forward Current | I _{SM} | integral revers p - n junction | \smile | - | - | 53 | A |
| Diode Forward Voltage | V _{SD} | T _J = 25 ° | C, I _S = 11 A, V _{GS} = 0 V | - | 0.9 | 1.2 | V |
| Reverse Recovery Time | t _{rr} | | | - | 135 | 270 | ns |
| Reverse Recovery Charge | Q _{rr} | | 5 °C, $I_F = I_S = 11 \text{ A}$, | - | 0.76 | 1.52 | μC |
| Reverse Recovery Current | I _{RRM} | dl/dt = 100 A/µs, V _R = 400 V | | - | 11 | - | A |

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS} . b. $C_{oss(tr)}$ is a fixed capacitance that gives the charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS} .



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

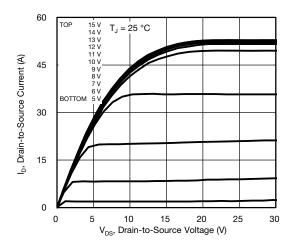


Fig. 1 - Typical Output Characteristics, T_J = 25 °C

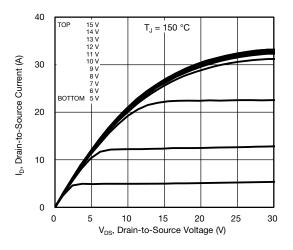


Fig. 2 - Typical Output Characteristics, T_J = 150 °C

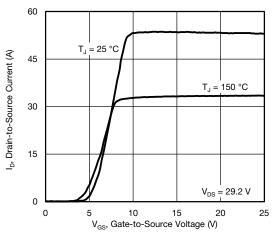


Fig. 3 - Typical Transfer Characteristics

S17-0299-Rev. B, 27-Feb-17

3



3.0 R_{DS(on)}, Drain-to-Source On-Resistance 2.5 2.0 (Normalized) 1.0 10 0.5 0 80 100 120 140 160 -60 -40 -20 0 20 40 60 T_J, Junction Temperature (°C)

Fig. 4 - Normalized On-Resistance vs. Temperature

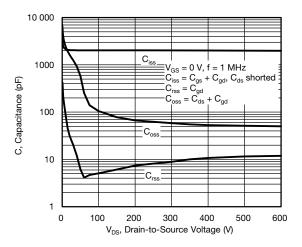
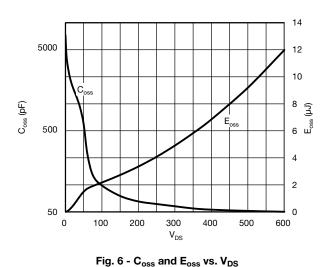


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage





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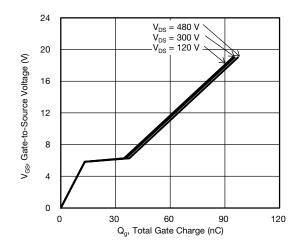


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

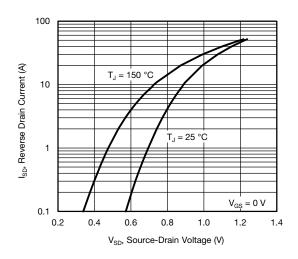


Fig. 8 - Typical Source-Drain Diode Forward Voltage

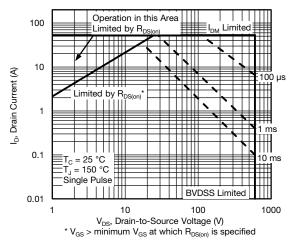


Fig. 9 - Maximum Safe Operating Area

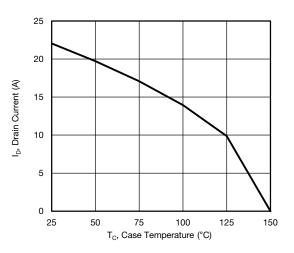


Fig. 10 - Maximum Drain Current vs. Case Temperature

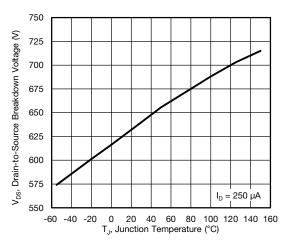
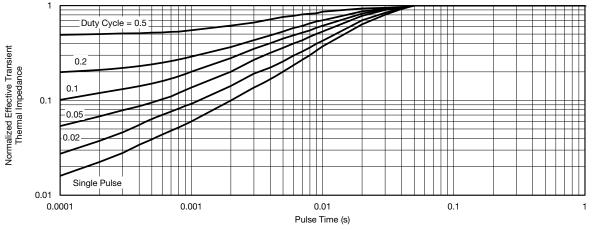


Fig. 11 - Typical Drain-to-Source Voltage vs. Temperature



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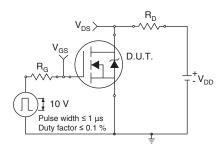


Fig. 13 - Switching Time Test Circuit

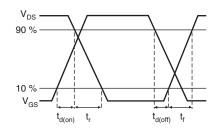


Fig. 14 - Switching Time Waveforms

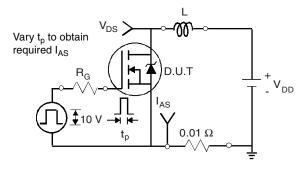


Fig. 15 - Unclamped Inductive Test Circuit

S17-0299-Rev. B, 27-Feb-17

Fig. 16 - Unclamped Inductive Waveforms

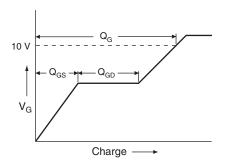
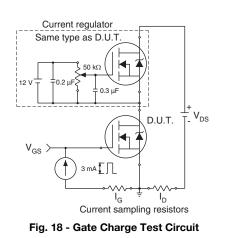


Fig. 17 - Basic Gate Charge Waveform

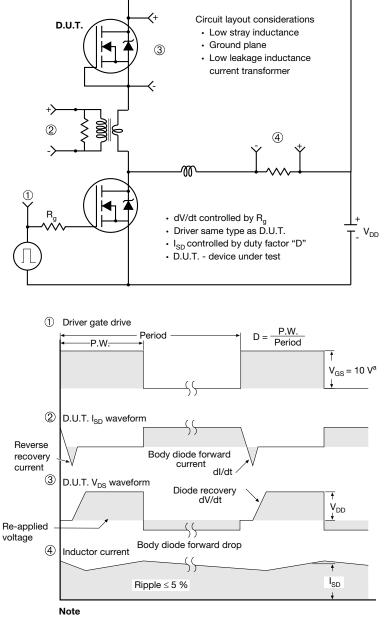


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Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

Fig. 19 - For N-Channel

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H

A1

B

Gauge plane

L3

Detail "A" Rotated 90° CW scale 8:1

0° to 8° **Vishay Siliconix**

Seating plane

TO-263AB (HIGH VOLTAGE)

∕3 ⁄4 A

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Detail A

(Datum A)

D

 $\underline{4}$ 11

| | 2 | - | Y 2 x b2 2 x b ⊕ 0.010 @ A(| ■ ating 5 b1, b b1, b b1, b c) c) c) c) c) c) c) c) c) c) | $\begin{array}{c} c_{1} \\ c_{1} \\ c_{2} \\ c_{3} \\ c_{4} \\ c_{5} \\ c_{5} \\ c_{7} \\$ | a - 1 | | Ū. | 1 <u>4</u> | |
|--------------------------------|--|--|--|---|---|-------------------------------|---|---|--|--|
| | MILLIN | IETERS | INCHES | | | | MILLIN | METERS INCHE | | HES |
| DIM. | MIN. | MAX. | MIN. | MAX. | | DIM. | MIN. | MAX. | MIN. | MAX. |
| А | 4.06 | 4.83 | 0.160 | 0.190 | | D1 | 6.86 | - | 0.270 | - |
| | | | | 0.010 | | - | | 10.07 | 0.000 | 0.420 |
| A1 | 0.00 | 0.25 | 0.000 | 0.010 | | E | 9.65 | 10.67 | 0.380 | 0.120 |
| A1 b | 0.00 0.51 | 0.25 0.99 | 0.000 | 0.010 | | E1 | 9.65 6.22 | - 10.67 | 0.380 | - |
| | | | | | | | 6.22 | - 10.67 - BSC | 0.245 | - BSC |
| b | 0.51 | 0.99 | 0.020 | 0.039 | | E1 | 6.22 | - | 0.245 | - |
| b b1 | 0.51 0.51 | 0.99 0.89 | 0.020 0.020 | 0.039 0.035 | | E1 e | 6.22 2.54 | - BSC | 0.245 | -) BSC |
| b b1 b2 | 0.51 0.51 1.14 | 0.99 0.89 1.78 | 0.020 0.020 0.045 | 0.039 0.035 0.070 | | E1 e H | 6.22 2.54 14.61 | - BSC 15.88 | 0.245 0.100 0.575 | -) BSC 0.625 |
| b b1 b2 b3 | 0.51 0.51 1.14 1.14 | 0.99 0.89 1.78 1.73 | 0.020 0.020 0.045 0.045 | 0.039 0.035 0.070 0.068 | | E1 e H L | 6.22 2.54 14.61 1.78 | - BSC 15.88 2.79 | 0.245 0.100 0.575 0.070 | - 0 BSC 0.625 0.110 |
| b b1 b2 b3 c | 0.51 0.51 1.14 1.14 0.38 | 0.99 0.89 1.78 1.73 0.74 | 0.020 0.020 0.045 0.045 0.015 | 0.039 0.035 0.070 0.068 0.029 | | E1 e H L L1 | 6.22 2.54 14.61 1.78 - - | - BSC 15.88 2.79 1.65 | 0.245 0.100 0.575 0.070 - - | - 0 BSC 0.625 0.110 0.066 |
| b b1 b2 b3 c c1 | 0.51 0.51 1.14 1.14 0.38 0.38 | 0.99 0.89 1.78 1.73 0.74 0.58 | 0.020 0.020 0.045 0.045 0.015 0.015 | 0.039 0.035 0.070 0.068 0.029 0.023 | | E1 e H L L1 L2 | 6.22 2.54 14.61 1.78 - - | - BSC 15.88 2.79 1.65 1.78 | 0.245 0.100 0.575 0.070 - - | - 0 BSC 0.625 0.110 0.066 0.070 |

А

Notes

1. Dimensioning and tolerancing per ASME Y14.5M-1994.

2. Dimensions are shown in millimeters (inches).

3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body at datum A.

4. Thermal PAD contour optional within dimension E, L1, D1 and E1.

5. Dimension b1 and c1 apply to base metal only.

6. Datum A and B to be determined at datum plane H.

7. Outline conforms to JEDEC outline to TO-263AB.



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1



RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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